

CERAMIC DISC CAPACITOR SAFETY RECOGNIZED, AC SERIES(pitch5mm)

Ver:16

Page:1 / 19

PRODUCT SPECIFICATION

PRODUCT: CERAMIC DISC CAPACITOR SAFETY RECOGNIZED For PITCH: 5mm

TYPE: AC SERIES

CUSTOMER:

DOC. NO.: POE-D12-00-E-16

APPROVED BY CUSTOMER

VENDOR:

■ WALSIN TECHNOLOGY CORPORATION

566-1, KAO SHI ROAD,YANG-MEI

TAO-YUAN, TAIWAN

☐ PAN OVERSEAS (GUANGZHOU) ELECTRONIC CO.,LTD.

NO.277,HONG MING ROAD,EASTERN SECTION, GUANG ZHOU ECONOMIC AND TECHNOLOGY DEVELOPMENT ZONE,CHINA

☐ DONGGUAN WALSIN TECHNOLOGY ELECTRONICS CO., LTD.

NO.638, MEI JING WEST ROAD,XINIUPO,ADMINISTRATIVE ZONE,DALANGTOWN,DONGGUAN CITY, GUANGDONG PROVINCE

MANUFACTURE SITE:

V PAN OVERSEAS (GUANGZHOU) ELECTRONIC CO.,LTD.

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Record of change

Date	Version	Description	page
2008.6.3	1	1. D24-00-E-01(before) \rightarrow POE-D12-00-E-01(1 st edition)	1 8
2008.8.22	2	1 Complete lead code	19
2000.0.22	_	2. Add last SAP code "H" for halogen and Pb free, epoxy resin	3
2008.12.12	3	1. Complete the 13 th to 17 th codes of SAP P/N.	4
		2. Page layout adjustment.	
2009.7.16	4	1 Change PSA & POE logo to Walsin & POE logo.	
		2. Complete Marking statement.	9
		3. Revised standard NO. of SEV, SEMKO, FIMKO, NEMKO, DEMKO and KEMA.	11
		Revised recognized NO. of FIMKO, NEMKO, DEMKO, KEMA and	
		CQC.	
		4. Downsize:	6
2009.9.14	5	1. "Protrusion length": "1.0max" revised to "2.0max (Or the end of lead	8
		wire may be inside the tape.)"	
2009.12.24	6	1. Delete the P/N of diameter above 10 mm.	6
		2. Marking	9 10
		3. Correct recognized No4. Revised the Figure of impulse voltage test(Item 7.3.14) according to	10 14
		the standard IEC 60384-14 ed.3	17
2011/1/13	7	1. Review SAP P/N about diameter code:	6
		2. Delete "AT" taping type.	4,5,8
		3. Add test item "Temperature Cycle".	15
		4. Add item 10 "Drawing of internal structure and material list"	20
2011/5/13	8	1. Add "1AC" type;	4
		2. Define the marking of the type "0AC" and "1AC";	9
		3. Delete "old P/N"	6~8
		4. Review the "Standard No. & Subclass & W.V. & Recognized No".	10
2012/2/7	9	1. Review the "Standard No. & Subclass & W.V. & Recognized No".	9
		2. Review the "Operating Temperature Range" from "-25 to +125°C" to "-40 to	10
		+125°C"	
		3. Review the temperature of Step 1from "-25+0/-3" to "-40+0/-3"	14
2012/4/6	10	1. In order to improve the traceability of the product, change the date	8
		code on capacitor body, new date code can trace back to production	
		"Lot No."	
2013/5/6	11	1. Review the Lead diameter φ from 0.60 +0.1/-0.05mm to 0.55+/-0.05mm	5,6,7
		2. In order the customer to know the round time of manufacture, review	8
		the date code on capacitor body, new date code can know the month of manufacture.	
			O
		 3. Delete "No marked with "_" stand for Pb free". Add "epoxy resin" 4. Review the Solderability time from 2±0.5s to 5±0.5s 	8 11
		·	
		 Review the "Manufactured Date" to "Products ID" on the marking page Delete "The marking can be printed on either one side or two side of coating 	8
2012/10/16	10	body." and add "for SAP part number 10-11 digits \leq '07' products"	8
2013/10/16	12	to two sides and "for SAP part number 10-11 digits \geq 07 products"	
		to two sides and for SAP part number 11-12 digits ≥ 08 products to one side.	
		to one side.	



Record of change (continue)

Date	Version	Description	page				
2014/11/5	13	 Review the terminal position of the lead wire. Review the product of ID, add the code "D" for the products of Dongguan Walsin Technology Electronics Co., Ltd. 	7 8				
2016/1/27	14	 Review the Available lead code of Lead Configuration Revised standard NO. of VDE, SEV, SEMKO, FIMKO, NEMKO and DEMKO. 	5 9				
2016/5/3	15	1. Delete 6 pF~10 pF for P/N CH*AC***D06* *, 12 pF~15 pF for P/N CH*AC120J06* *,18 pF~24 pF for P/N CH*AC***J07* *, 27 pF~33 pF for P/N CH*AC***J08* *, and 36 pF~39 pF for P/N CH*AC***J09* *.	6				
2016/11/3	16	1. Delete "CH" series.	4,6,10~14,19				

Table of Contents

No.	Item	Page
1	Part number for SAP system	4
2	Mechanical	5
3	Part numbering/T.C/Capacitance/ Tolerance/Diameter	6
4	Taping Format	7
5	Marking	8
6	Scope	9
7	Specification and test method	10~14
8	Packing specification	15
9	Notices	16~18
10	Drawing of Internal Structure and material list	19



1. Part number for SAP system

(Ex.) \underline{YV} $\underline{0AC}$ $\underline{472}$ \underline{M} $\underline{10}$ $\underline{0}$ \underline{L} $\underline{20}$ \underline{C} $\underline{5}$ \underline{B} (1) (2) (3) (4) (5) (6) (7) (8) (9) (10) (11)

(1)Temperature characteristic (identified code)

CODE	SL	YP (Y5P)	YV(Y5V)	YU (Y5U)
Cap. Change	-1000~+350PPM/°C (+20°C~+85°C)	±10%	-80% ~ +30%	-55% to +20%

(2)TYPE (identified by 3-figure code) : 0AC = X1:400Vac/Y2:250Vac

(3)Capacitance (identified by 3-figure code) : EX.221=220pF

(4) Capacitance tolerance (identified by code) $: C:\pm 0.25 pF, D:\pm 0.5 pF, J:\pm 5\%, K:\pm 10\%, M:\pm 20\%$

(5) Nominal body diameter dimension (identified by 2-figure code): 06--Dmax7.0mm, 07--Dmax8.0mm...

(6)Internal code: 0--Normal, other code--Special control

(7)Lead Style: Refer to "2. Mechanical".

(8)Packing mode and lead length (identified by 2-figure code)

Taping Code	Description
AN	Ammo box and product pitch: 12.7mm
AM	Ammo box and product pitch: 25.4 mm

Bulk Code	Description		
03	Lead length: 3.0mm		
3E	Lead length: 3.5mm		
04	Lead length: 4.0mm		
4E	Lead length: 4.5mm		
20	Lead length: 20.0mm		

(9) Tolerance of lead length

Code	Description			
A	±0.5 mm			
	(only for kink lead type)			
В	±1.0 mm			
С	Min.			
D	Taping special purpose			

(10)Lead space

Code	Description		
5	5.0 ± 0.8 (For Bulk)		
3	5.0+0.8/-0.2mm(For Taping)		
Е	5.0 ± 0.5 mm		

(11)Epoxy resin code

Code	Description		
В	Pb free, Epoxy Resin		
Н	Halogen and Pb free, epoxy resin.		



2. Mechanical

Encapsulation: Epoxy resin, flammability UL94 V-0

Available lead code(unit: mm)

Lead type	SAP P/N (13-17)digits	Lead space (F)	Lead Length (L)	Packing	Lead Configuration	
	L03B5		3.0 ± 1.0		Dmax. Tmax.	
Lead style: L	L3EB5		3.5 ± 1.0		e De	
Type L Straight long lead	L4EB5	5.0 ± 0.8	4.5 ± 1.0	Bulk	Ød A	
	L20C5		20 min.		<u> </u>	
Lead style: B Type B	BAND5	5.0+0.8/-0.2	Refer to "4. Taping format"	Tap. Ammo	Dmax. Tmax.	
Straight long lead	BAMD5				ϕ_{d}	
	D03A5		3.0 ± 0.5		Dmax. Tmax.	
Lead style: D	D3EA5	5.0 ± 0.8	3.5 ± 0.5	Bulk		
Type D	D04A5		4.0 ± 0.5		4 max	
Vertical kink lead	DAND5	5.0+0.8/-0.2	Refer to "4.	Tap. Ammo	Ød L	
	DAMD5	3.0+0.8/-0.2	Taping format"			
	X03A5		3.0 ± 0.5			
Y 1 . 1 . Y	X3EA5	5.0 ± 0.8	3.5 ± 0.5	Bulk	Dmax. Tmax.	
Lead style: X	X04A5		4.0 ± 0.5		X X X X X X X X X X X X X X X X X X X	
Type X Outside kink lead	XAND5	5.0+0.8/-0.2	Refer to "4. Taping format"	Tap. Ammo	S.0max	
Subject Kill letter	XAMD5	3.0+0.8/-0.2				

^{*} Lead diameter Φd: 0.55 +/-0.05mm

^{*} Coating extension on leads): 3.0mmMax for straight lead lead style; Not exceed the kink for kink lead.

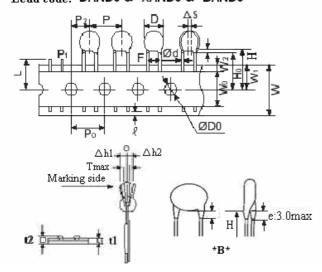


3. Part numbering/T.C/Capacitance/ Tolerance/Diameter:

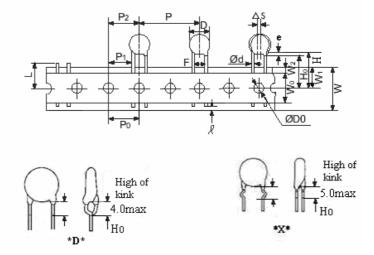
3. Part numbering/T.C/Capacitance/ Tolerance/Diameter:								
				Dimensions (unit: mm)				
SAP P/N	T.C.	Capacitance	Tolerance	D	Т		F	φd
				(max)	(max)	Bulk type	Taping type	φα
SL*AC***J060*		10,12,15,18,20,22,2 4,27,30,33, 36,39,47,50,51(pF)	±5%	7.0			•	
SL*AC***J070*	SL	56,62, 68,75(pF)	±5%	8.0				
SL*AC820J080*		82pF	±5%	9.0				
SL*AC101J090*		100pF	±5%	10.0				
YP*AC101K060*		100 pF	±10%	7.0				
YP*AC151K060*		150 pF	±10%	7.0				
YP*AC221K060*		220 pF	±10%	7.0			5.0+0.8/-0.2	
YP*AC331K060*		330 pF	±10%	7.0			(AND5)	
YP*AC471K060*	Y5P	470 pF	±10%	7.0			,	
YP*AC561K070*		560 pF	±10%	8.0				
YP*AC681K070*		680 pF	±10%	8.0				
YP*AC821K080*		820 pF	±10%	9.0				
YP*AC102K080*		1000 pF	±10%	9.0	5.0	5.0±0.8		0.55±0.05
YU*AC102M060*		1000 pF	±20%	7.0	3.0	5.0_0.0		0.00_0.00
YU*AC152M080*		1500pF	±20%	9.0				
YU*AC222M080*	Y5U	2200 pF	±20%	9.0				
YU*AC332M100*	130	3300 pF	±20%	11.0			50.00/02	
YU*AC392M120*		3900 pF	±20%	13.0			5.0+0.8/-0.2 (AMD5)	
YU*AC472M120*		4700 pF	±20%	13.0			(AMD3)	
YV*AC102M060*		1000 pF	±20%	7.0				
YV*AC152M060*	Y5V	1500 pF	±20%	7.0			5.0+0.8/-0.2	
YV*AC222M060*	130	2200 pF	±20%	7.0			(AND5)	
YV*AC332M080*		3300 pF	±20%	9.0				
YV*AC392M100*		3900 pF	±20%	11.0]			
YV*AC472M100*		4700 pF	±20%	11.0			5.0+0.8/-0.2	
YV*AC682M120*		6800 pF	±20%	13.0			(AMD5)	
YV*AC103M140*		10000 pF	±20%	15.0				

4. Taping Format:

 12.7mm pitch/lead spacing 5.0mm taping Lead code: *DAND5 & *XAND5 & *BAND5



25.4mm pitch/lead spaceing 5.0mm taping
 Lead code: *DAMD5 & *XAMD5 & *BAMD5



POE Part Number		*BAND5 *BAMD5 *DAND5 *DAMD5 *XAND5 *XAMD5		
Item	Symbol	Dimensions (mm)	Dimensions (mm)	
Pitch of component	P	12.7	25.4	
Pitch of sprocket	P0	12.7±0.3	12.7±0.3	
Lead spacing	F	5.0+0.	.8/-0.2	
Length from hole center to component center	P2	6.35±1.5	12.7 ± 1.5	
Length from hole center to lead	P1	3.75±1.0	10.2±1.0	
Body diameter	D	See the "3. Part numbering/T.C/C	Capacitance/ Tolerance/Diameter"	
Deviation along tape, left or right	△S	0±2	2.0	
Carrier tape width	W	18.0 +	-1/-0.5	
Position of sprocket hole	W1	9.0±	±0.5	
Lead distance between the kink and center	НО	18.0+2.0/-0	18.0+2.0/-0	
of sprocket hole		(For: *DAND5 / *XAND5)	(For: *DAMD5 / *XAMD5)	
Lead distance between the bottom of body and the center of sprocket hole	Н	20.0+1.5/-1.0 (For: *BAND5)	20.0+1.5/-1.0 (For: *BAMD5)	
Length from the terminal of the lead wire to the edge of carrier tape	R	2.0min (Or the end of lead wire may be inside the hole-down tape		
Diameter of sprocket hole	D0	4.0	±0.2	
Lead diameter	φd	0.55±	±0.05	
Total tape thickness	t1	0.6=	±0.3	
Total thickness, tape and lead wire	t2	1.5 ɪ	nax.	
Deviation across tape	∆h1/∆h2	2.0 ɪ	nax.	
Portion to cut in case of defect	L	11.0 max.		
Hole-down tape width	W0	8.0	min	
Hole-down tape distortion	W2	3.0 max.		
Coating extension on leads	e	3.0 max for straight lead style; Not exceed the kink leads for kink le		
Body thickness	Т	See the "3. Part numbering/T.C/C	Capacitance/ Tolerance/Diameter"	



5.Marking:

AC					
Identified by 3-Figure Code. Ex. $47pF \rightarrow "47"$, $470pF \rightarrow "471"$					
C:±0.25pF,D:±0.5pF,J:±5%,K:±10%,M:±20%					
LK .					
Abbreviation ex. Manufacture year: ←6 C 6 1234 → Last 4 digits of lot no. 5:2015 6:2016 7:2017 Epoxy resin code: Manufacture month: 1:January 2:Feruary C:Pan overseas (Guangzhou) (For the last code "H" and "B" of SAP P/N) SAP P/N) SINDER C:December					
3 CSA					
Two sides marking (for SAP part number 10-11 digits ≤ "07" products) One side marking (for SAP part number 11-12 digits ≥ "08" products)					
AC471K (B) (C) (C) (D) (S) (N) (AC472M (

^{*&}quot;C", Marked with code "_" stand for Halogen and Pb free epoxy resin.



6. Scope

THIS SPECIFICATION APPLIES TO CERAMIC INSULATED CAPACITORS DISK TYPE USED IN ELECTRONIC EQUIPMENT.

- 1. VDE/SEV/SEMKO/FIMKO/NEMKO/DEMKO/UL/CSA recognized capacitor for Antenna coupling and AC line-by-pass.X1, Y2 Capacitor based on IEC 60384-14 "UL, CSA recognized for across-the-line, line-by-pass" and antenna-isolation
- 2. Approval Standard and Recognized No.

Safety Standard	Standard No.	Subclass	w.v.	Recognized No.
UL	ANSI/UL	X1	400VAC	E146544
OL	60384-14:2009	Y2	250VAC	E140344
CSA	CAN/CSA	X1	400VAC	2347969
CSA	E60384-14:2009	Y2	250VAC	2347909
VDE	EN 60384-14:2013	X1	400VAC	40001829
(ENEC)	IEC60384-14:2013	Y2	250VAC	40001829
CEV	IEC60384-14:2013	X1	400VAC	14.0554
SEV		Y2	250VAC	14.0554
SEMKO	EN 60384-14:2013	X1	400VAC	1411212
SEMICO	EN 00384-14.2013	Y2	250VAC	1411212
FIMKO	EN 60384-14:2013	X1	400VAC	NCS/FI 28679A1
TIVIKO	LIV 00304-14.2013	Y2	250VAC	1VCS/11 2007 /A1
NEMKO	EN 60384-14:2013	X1	400VAC	P14219060
NEWIKO	LIN 00364-14.2013	Y2	250VAC	1 14219000
DEMKO	EN 60384-14:2013	X1	400VAC	D-03994 A1
DEWIKO	EN 00384-14.2013	Y2	250VAC	D-03994 A1
CQC	GB/T 14472-1998	X1:400VAC /Y1:250VAC		CQC08001026519
KTL	K60384-14 2006	X1	400VAC or 440VAC	SU03065-14001
KIL	K00304-14 2000	Y2	250VAC	SU03065-14002



7. Specification and test method:

7.1 Operating Temperature Range:

-40 to +125°C

7.2 Test condition:

Test and measurement shall be made at the standard condition. (temperature 15~35°C, relative humidity 45~75% and atmospheric pressure 860~1060hpa). Unless otherwise specified herein.

If doubt occurred on the value of measurement, and measurement was requested by customer capacitors shall be measured at the reference condition. (temperature $20\pm2^{\circ}\text{C}$ or $25\pm2^{\circ}\text{C}$, relative humidity $60\sim70\%$ and atmospheric pressure $860\sim1060$ hpa.)

7.3 Performance:

	Item			Specification	Testing Method				
		Between			The capacitors shall not be damage when AC2000V are applied				
		lead wires	No failure.		between the lead wires for 60 sec. (Charge/Discharge current				
					50mA.)				
	Dielectric)ielectric		ectric			First the terminal of capacitor shall be connected together. Then a metal foil shall be closely wrapped around the body of the capacitor		
1	Strength	D - J			distance of about 3 to 4 mm from each terminal. Then the capacitor				
		Body Insulation		No failure.	shall be inserted into a container filled with metal balls of about 1				
					mm diameter. Finally. AC2600V is applied for 60 sec. between the				
					capacitor lead wires and metal balls. (Charge/Discharge current 50mA.)				
2	Insulation Resis	tance(LR)	100001	MΩ min.	The insulation resistance shall be measured with 500±50VDC with				
		talice(I.K.)			60±5sec. of charging.				
3	Capacitance			specified tolerance					
			Char. Y5P,	Specification	B&E&F: The capacitance shall be measured at 20±2°C with				
	Dissipation Fort	(D.E.)	Y5U	D.F≦2.5%	1kHz±20% and 5V(rms.) or less.				
4	4 Dissipation Factor(D.F.) or Q		Dissipation Factor(D.F.) or		Y5V	D.F≦5.0%	SL: The capacitance shall be measured at 25°C with 1MHz±		
			CI	Q: 30pF&above: ≥ 1000 Below	20% and1.0±0.2Vrms				
			SL	30PF: ≥ 400+20×C					
				•	The capacitance measurement shall be made at each step specified in				
					table 1.				
			Char.	Capacitance Change	(Table 1) Step Temperature				
			Y5P	Within ±10%	1 +20±2°C				
5	Temperature Ch	aracteristic	Y5U	Within -55 ~ +20%	2 -25±2°C				
	remperature en	aracteristic	Y5V	Within -80 ~ +30%	3 +20±2°C				
			SL	-1000~+350ppm/°C (+20°C ~+85°C)	5 +20±2°C				
				[(120 C 1103 C)	Pr-treatment:				
					Capacitor shall be stored at 85±2°C for 1 hour. Then placed at room				
					condition for 1(*)24±2 hours before measurement				
			_		With the termination in its normal position the specimen is held by its body in such a manner that the axis of the termination is				
1		Tensile		ire shall not cut off	vertical: the tensile force of 10N shall be applied to the termination				
1		cap		or shall not be broken.	in the direction of its axis and acting in a direction away from the				
					body of the specimen.				
6	Robustness of				With the termination in its normal position the specimen is held by its body in such a manner that the axis of the termination is				
	Termination				vertical: a mass applying a force of 5N is then suspended from the				
		Lead wire shall not cut off		ire shall not cut off	end of the termination. The body of the specimen is then inclined				
1		Bending	capacito	or shall not be broken.	within a period of 2 to 3 sec., through an angle of approximately 90°				
					in the vertical plane and then resumed to its initial position over the same period of time; this operation constitutes one bend. One bend				
					immediately followed by a second bend in the opposite direction.				



	Item		Specification	Testing Method
7	Solderability of leads		Lead wire should be soldered with uniform coating on the axial direction over 3/4 of the circumferential direction.	The lead wire of capacitor should be dipped into molten solder for 5 ± 0.5 sec. The depth of immersion is up to about 1.5 to 2.0 mm from the root of lead wires.
		Appearance I.R.	No marked defect $1000 M\Omega$ min.	Temp. of solder : Lead free solder (Sn-3Ag -0.5 Cu) $245 \pm 5 \ ^{\circ}\text{C}$ As shown in figure, the lead wires should be immersed in solder of $350 \pm 10 \ ^{\circ}\text{C}$ or $260 \pm 5 \ ^{\circ}\text{C}$ up to 1.5 to 2.0mm from the root of
		Dielectric Strength	Per Item 1.	Terminal for 3.5 ± 0.5 sec (10 ± 1 sec for 260 ± 5 °C)
	Soldering Effect (Non-Preheat)	Capacitance	Y5P,Y5U,Y5V: Within ±10% SL: Within±2.5% or ±0.25pF,Whichever is large.	Pre-treatment: Capacitor shall be stored at 85±2°C for 1hour.then placed at **1room condition for 24±2hours before initial measurements. Post-treatment: Capacitor shall be stored for 1 to 2hours at **1room condition.
8		Appearance	No marked defect.	First the capacitor should be stored at $120 + 0 / -5$ °C for $60 + 0 /$ 5sec.
		I.R.	1000Μ Ω min.	Then, as in figure , the lead wires should be immersed solder of $260 + / -5$ °C up to 1.5 to 2.0 mm from the root of terminal for 7.5 $+0/-1$ sec.
	Soldering Effect (On-Preheat)	Dielectric Strength	Per Item 1.	Thermal Capacitor Screen 1.5 1.5
		Capacitance	Y5P,Y5U,Y5V: Within ±10% SL: Within±2.5% or ±0.25pF,Whichever is large.	Pre-treatment: Capacitor shall be stored at 85±2°C for 1hour.then placed at **1 room condition for 24±2 hours before initial measurements. Post-treatment: Capacitor shall be stored for 1 to 2 hours at **1 room condition.



	Item		Specification	Testing Method
9	Humidity (Under Steady State)	Appearance Capacitance	No marked defect. Y5P: Within ±10% Y5U: Within ±20% Y5V: Within ±30% SL: Within±2.5% or ±0.25pF,Whichever is large. Y5P,Y5U: 5.0% max.	Set the capacitor for 500 ± 12 hours at $40\pm2^{\circ}$ C, in 90 to 95% humidity. Then capacitor shall be stored for 1 to 2 hours at room condition.
		D.F.	Y5V: 7.5% max.	
10	Humidity Loading	Q	SL: Less than 30pF=> $Q \ge 100+10 \times C/3$ More than 30pF=> $Q \ge 200$	Apply the rated voltage for 500 ± 12 hours at $40\pm2^{\circ}$ C, in 90 to 95% humidity and set it for 1 to 2 hours at room condition.
		I.R.	Y5P,Y5U,Y5V:3000MΩ min. SL: 1000MΩ min.	
		Appearance	No marked defect.	Impulse Voltage: Each individual capacitor shall be subjected to a 5kv impulses for
		Capacitance	Y5P,Y5U,Y5V: Within ±20% SL: Within±3% or ±0.3pF,Whichever is large.	three times. After the capacitors are applied to life test. $\begin{array}{c ccccccccccccccccccccccccccccccccccc$
		I.R.	3000MΩ min. SL: 1000MΩ min.	0.1 1.5 47
11	Life	Dielectric Strength	Per Item 1.	Fig. The specimen capacitors are placed in a circulating air oven for a period of 1000 hrs. The air in the oven is maintained at a temperature of 125±2°C. Throughout the test. The capacitors are subjected to an AC425Vrms.(for 2AC type) or AC510Vrms.(for 3AC type) alternating voltage of mains frequency. Except that once each hour the voltage id increased to 1000Vrms for 0.1sec.
12	Flame Test	The capacitor fla Cycle 1~4 5	me discharge as follows. Time 30 sec, max. 60 sec, max.	The capacitor shall subject to applied for 15 sec And then removed for 15 sec, until 5 cycles. Fig. Capacitor Flame Gas Burmer (Unit: mm)



	Item	Specification	Testing Method
13	Active Flammability	The cheesecloth shall not be on fire.	The specimens shall be individually wrapped in at least one but more then two complete layers of cheesecloth. The specimens shall be subjected to 20 discharges. The interval between successive discharges shall be 5sec. The Uac shall be maintained for 2 min. after the last discharge. Fig. F L1 L2 C3 R F L1 L2 C3 R Oacilloscpoe C1,2: 1Mf±10% C3: 0.03Mf±5% 10KV L1-4: 1.5Mh±20% 16A Rod core choke R: 100Ω±2% Ct: 3Mf±5% 10KV Uac: Ur±5% Ur: Rated working voltage Cx: Capacitor F: Fuse, Rated 10A Ut: Voltage applied to Ct
14	Passive Flammability	The burning time shall not be exceeded the time 30 sec. The tissue paper shall not ignite.	The capacitor under test shall be held in the flame in the position, which best promotes burning. Each specimen shall only be exposed once to the flame. Time of exposure to flame: 30 sec Length of flame: 12±1 mm Gas burner: Length 35 mm min. Inside Dia.: 0.5±0.1 mm Outside Dia.: 0.9 mm max. Gas: Butane gas Purity 95% min. Fig. approxiracaly 8 mm Test specimen Tissue



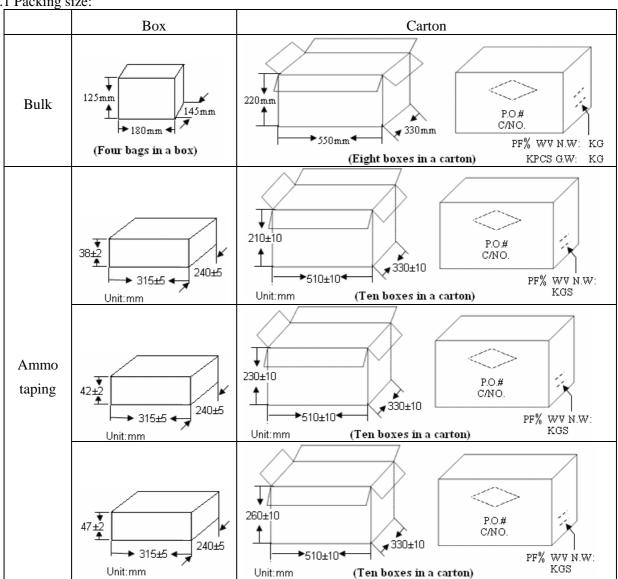
Item Specification					Testing Meth	ıod			
		Appear	ance	No marked defect	The capacito	or shou	ld be subjected to 5	temperature	cycles,
		Char.	Cap. Change	DF/Q		<ter< td=""><td>nperature Cycle tim</td><td>e: 5 cycles></td><td></td></ter<>	nperature Cycle tim	e: 5 cycles>	
				Q≥275+5/2C (C<		Step	Temperature($^{\circ}$ C)	Time(min)	
		SL	≦±5%	30pF) Q≥350 (C≥30pF)		1	-40+0/-3	30	
	_	Y5P	≦±10%	DF≦5.0%		2	Room temp.	3	
15	Temperature Cycle	Y5U, Y5V	≦±20%	DF≦7.5%		3	125+3/-0	30	
			I.R.	3000MΩ min.		4	Room temp.	3	
			Per Item 1	Pre-treatment: Capacitor shall be stored at 85±2°C for 1hour.then place at*1room condition for 24±2hours. Post-treatment: Capacitor shall be stored for 1 to 2hours at *1rocondition.					

 $[\]mbox{\%}$ "room condition" temperature $\mbox{:}\ 15\mbox{-}35\mbox{\%}$, humidity $\mbox{:}\ 45\mbox{-}75\mbox{\%}$,atmospheric pressure $\mbox{:}\ 86\mbox{-}106\mbox{kPa}$



8.Packaging Baggage:

8.1 Packing size:



8.2 Packing quantity:

Packing type	The code of 14th to 15th in SAP P/N	MPQ(Kpcs/Box)
Taping	AN	1

Packing type	Lead length	Size code of 10th to 11th in SAP P/N	MPQ (Kpcs/Bag)	Kpcs/Box
	Long lead	Long lead 06~12		1.5
	$(L \ge 20 \text{mm})$	13-15	0.5	1
Bulk	Short lead	06~14	0.5	2
	(L<20mm)	15	0.2	1
	All	16	0.2	1



9. Notices:

9.1 Caution(Rating):

(1). Operating Voltage

Be sure to maintain the Vp-p value of the applied voltage or the Vo-p which contains DC bias within the rated voltage range.

When the voltage is started to apply to the circuit or it is stopped applying, the irregular voltage may be generated for a transit period because of resonance or switching. Be sure to use a capacitor within rated voltage containing this irregular voltage.

Voltage	DC Voltage	DC+AC Voltage	AC Voltage	Pulse Voltage (1)	Pulse Voltage (2)
Positional Measurement	Vo-p	V _{0-p}	Vp-p	Vp-p	Vp-p

(2). Operating Temperature and Self-generated Heat

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself. When the capacitor is used in a high-frequency current, pulse current or the like, it may have the self-generated heat due to dielectric-loss. Applied voltage should be the load such as self-generated heat is within 20°C on the condition of atmosphere temperature 25°C . When measuring, use a thermocouple of small thermal capacity-K of $\phi 0.1 \text{mm}$ and be in the condition where capacitor is not affected by radiant heat of other components and wind of surroundings. Excessive heat my lead to deterioration of the capacitor's characteristics and reliability.

(3). Test condition for withstanding Voltage

I. Test Equipment

Test equipment for AC withstanding voltage shall be used with the performance of the wave similar to 50/60 Hz sine waves.

If the distorted sine wave or over load exceeding the specified voltage value is applied, the defective may be caused.



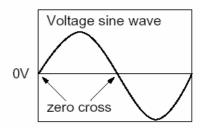
II. Voltage Applied Method

When the withstanding voltage is applied, capacitor's lead or terminal shall be firmly connected to the output of the withstanding voltage test equipment, and then the voltage shall be raised from near zero to the test voltage.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, test voltage should be applied with the *zero cross. At the end of the test time, the test voltage shall be reduced to near zero, and then capacitor's lead or terminal shall be taken off the output of the withstanding voltage test equipment.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, the surge voltage may arise, and therefore, the defective may be caused.

ZERO CROSS is the point where voltage sine wave pass 0V.- See the right figure.



(4). Fail-Safe

When capacitor would be broken, failure may result in a short circuit. Be sure to provide an appropriate fail-safe function like a fuse on your product if failure would follow an electric shock, fire or fume.

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

9.2 Caution (Storage and operating condition):

Operating and storage environment

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed –10 to 40 degrees centigrade and 15 to 85 % for 6 months maximum and use within the period after receiving the capacitors.

"Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used."

9.3 Caution (Soldering and Mounting):

9.3.1 Vibration and impact:

Do not expose a capacitor or its leads to excessive shock or vibration during use.



9.3.2 Soldering:

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

When soldering capacitor with a soldering iron, it should be performed in following conditions.

Temperature of iron-tip: 400 degrees C. max.

Soldering iron wattage: 50W max.

Soldering time: 3.5 sec. max.

9.3.3 Cleaning (ultrasonic cleaning):

To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity: Output of 20 watts per liter or less.

Rinsing time: 5 min maximum.

Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the lead wires.

"Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used."

9.4 Caution (Handling):

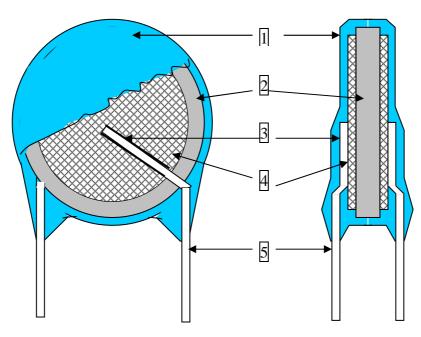
Vibration and impact

Do not expose a capacitor or its leads to excessive shock or vibration during use.

"Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used."



10. Drawing of internal structure and material list:



Remarks:

No.	Part name	Material	Model/Type	Component
1		Г 1	1.EF-150	Epoxy resin、Pigment
1	Insulation Coating	Epoxy polymer	2.PCE-300	(Blue / UL 94 V-0)
2	Dielectric Element	Ceramic	SL/Y5P/Y5U/Y5V	BaTiO ₃
3	Solder	Tin-silver	Sn96.5-Ag3-Cu0.5	Sn96.5-Ag3-Cu0.5
	F1 1		1.SP-160PL	C'1 C1 C''
4	Electrodes	Electrodes Ag		Silver · Glass frit
_	Tinned copper		0.55+0.05 mm	Substrate metal: Fe & Cu
5	Leads wire	steel wire	0.55±0.05 mm	Surface plating: Sn 100%(3~7μm)